

DFN0603 ESD

DFN0603 Plastic Package 1-Line,Bi-directional , ESD Protection Diode.

Stand-off voltage: $\pm 12\text{V}$ Max;

Transient protection for each line according to:

IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact);IEC61000-4-4 (EFT): 40A (5/50ns);IEC61000-4-5(surge): 6A (8/20 μs);Ultra-low capacitance: $C_J = 5\text{pF}$ typ;

Low leakage current;

Low clamping voltage: $V_{CL} = 21.0\text{V}$ typ. @ $I_{PP} = 16\text{A}$ (TLP);

Solid-state silicon technology;

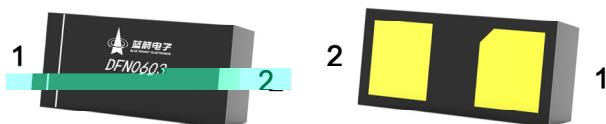
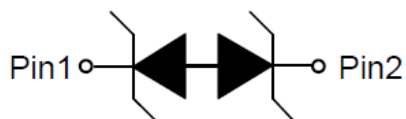
HF Product.

Computers and peripherals;

Audio and video equipment;

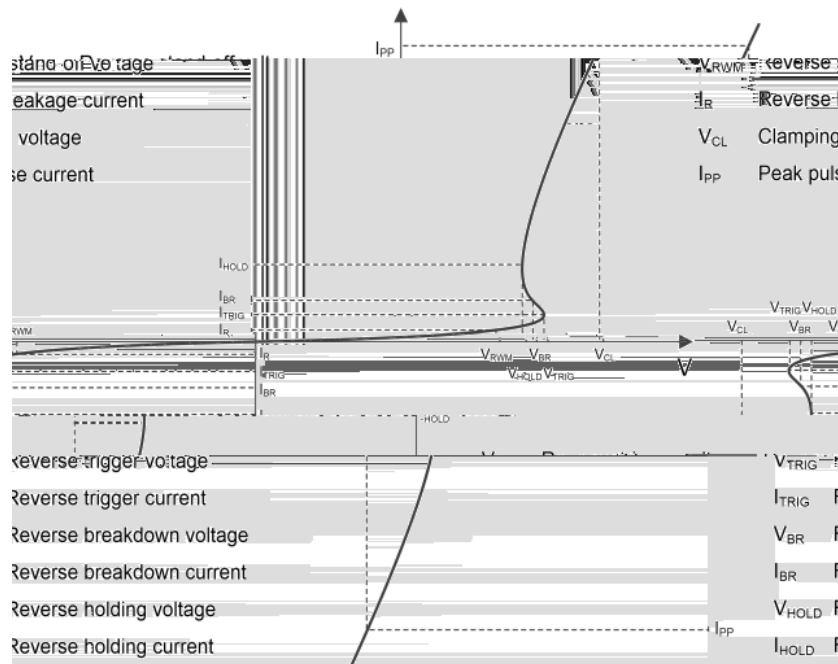
Communication systems;

Portable electronics.



See Marking Instructions.

Parameter	Symbol	Rating	Unit
Peak Pulse Power($t_p = 8/20\mu s$)	P_{PK}	120	W
Peak Pulse Current($t_p = 8/20\mu s$)	I_{PP}	6	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	125	
Operating temperature	T_{OP}	-40~85	
Lead temperature	T_L	260	
Storage Temperature	T_{STG}	-55~+150	



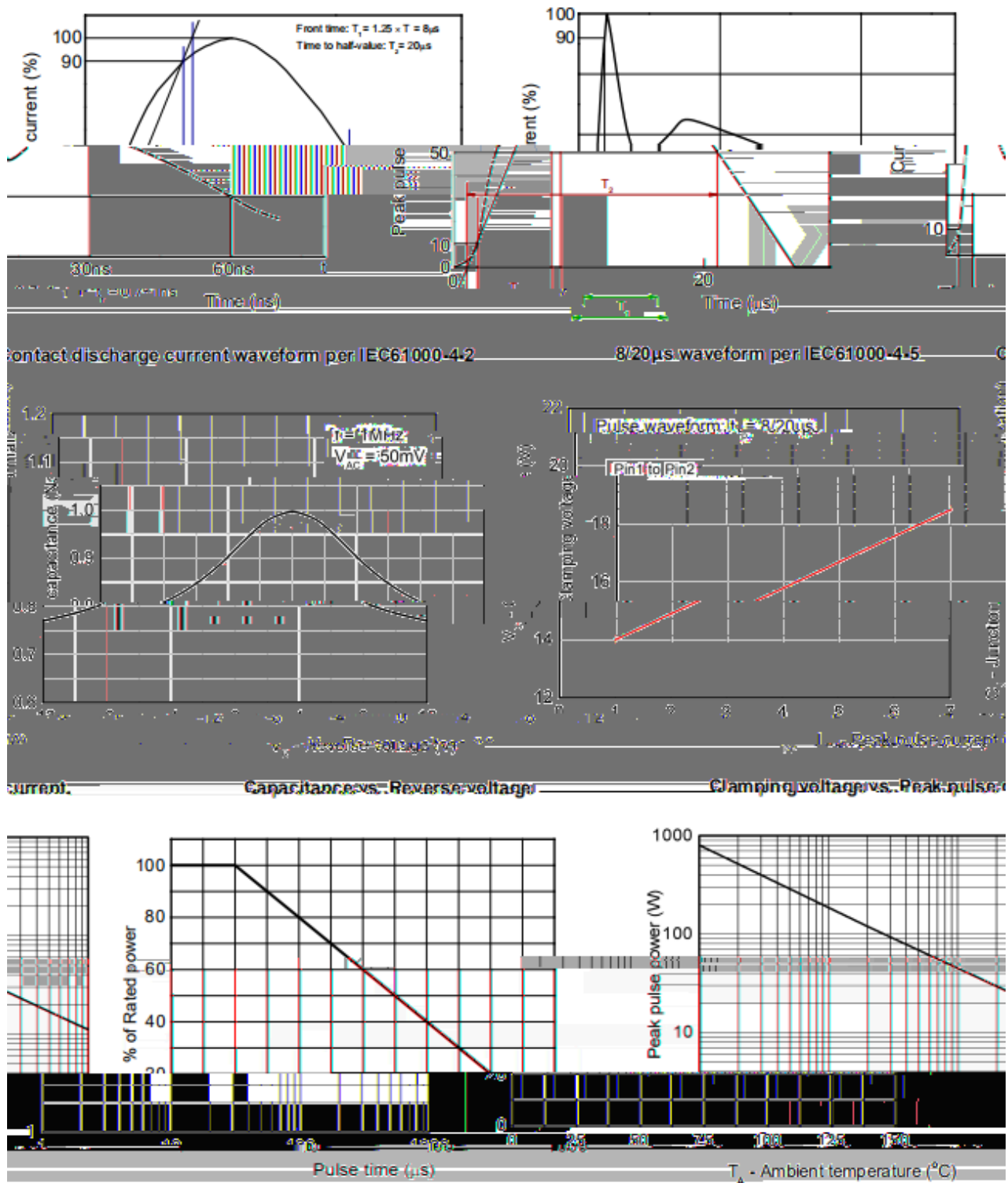
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Reverse maximum working voltage	V_{RWM}				12	V
Reverse leakage current	I_R	$V_{RWM} = 12V$			100	nA
Reverse breakdown voltage	V_{BR}	$I_{BR}=1mA$	13	14		V
Reverse holding voltage	V_{HOLD}	$I_{HOLD}=50mA$	13	14		V
Clamping voltage ¹⁾	V_{CL}	$I_{PP}=16A \quad t_p=100ns$		21.0		V
Dynamic resistance ¹⁾	R_{DYN}			0.35		Ω
Clamping voltage ²⁾	V_{CL}	$V_{ESD}= 8kV$		21.0		V
Clamping voltage ³⁾	V_{CL}	$I_{PP} = 1A \quad t_p = 8/20\mu s$		14	16	V
		$I_{PP} = 6A \quad t_p = 8/20\mu s$		18.5	20	V
Junction Capacitance	C_J	$V_R = 0V \quad f = 1MHz$		5	7	pF
	C_J	$V_R = 2.5V \quad f = 1MHz$		4	6	pF

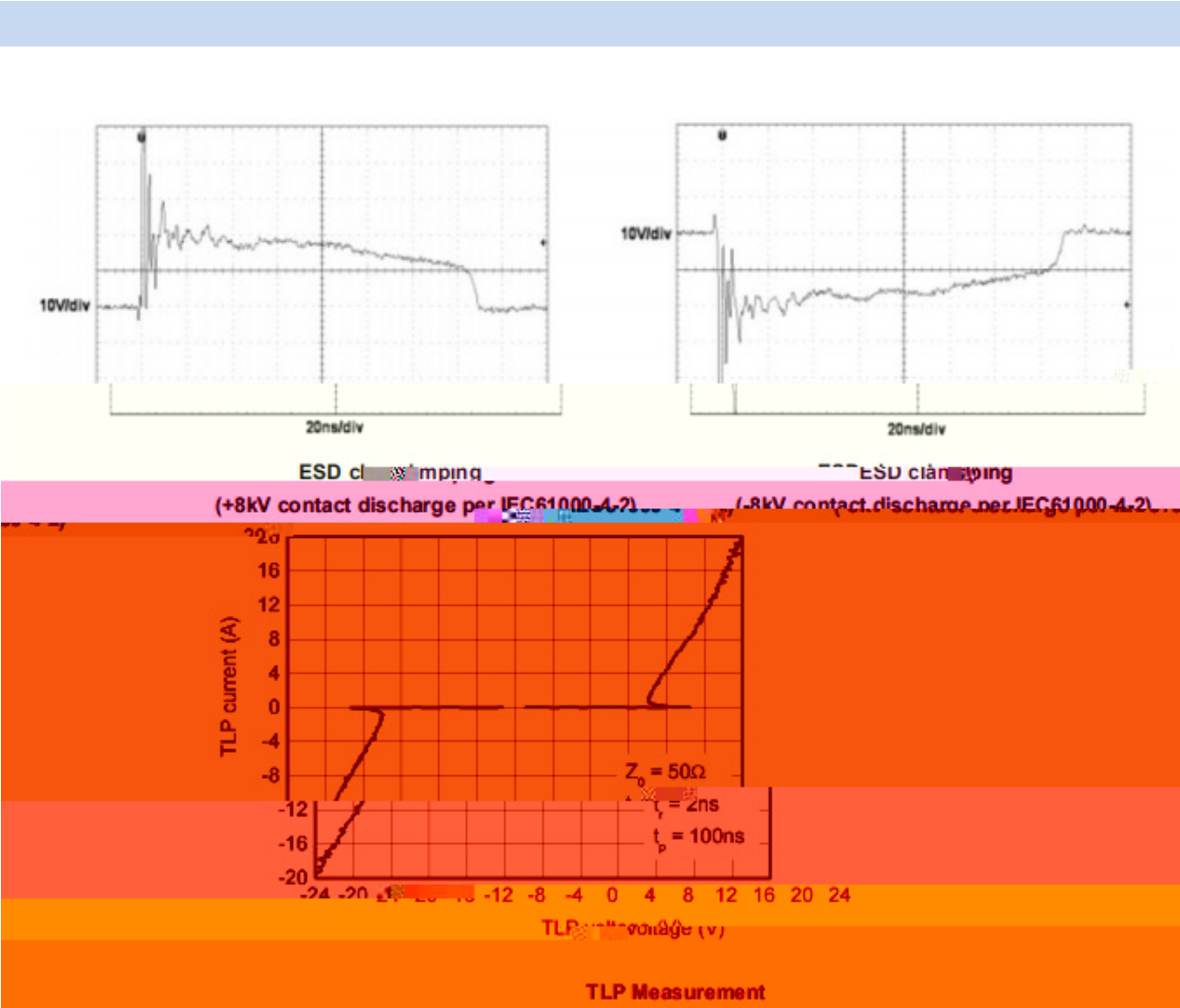
Notes:

1) TLP parameter: $Z_0 = 50 \Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

2) Contact discharge mode, according to IEC61000-4-2.

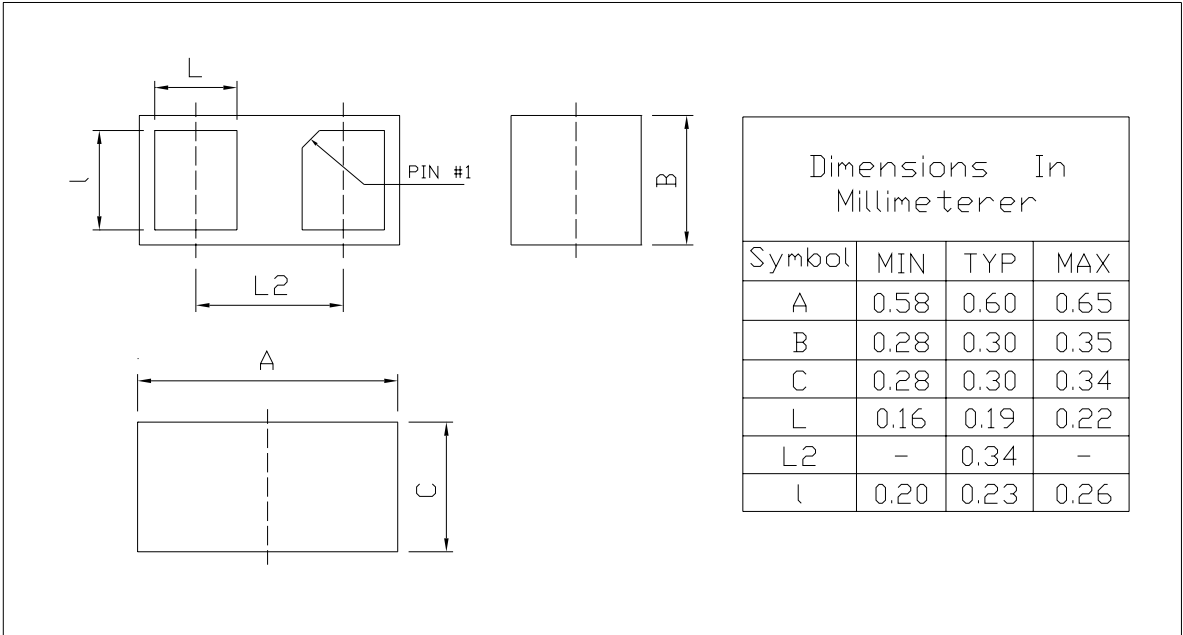
3) Non-repetitive current pulse, according to IEC61000-4-5.



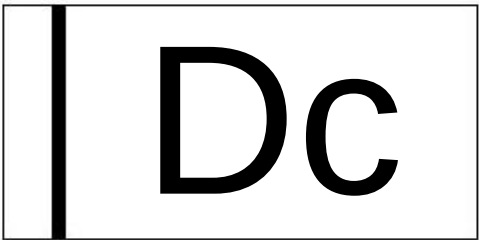


DFN0603

Unit:mm



Rev.02 202102

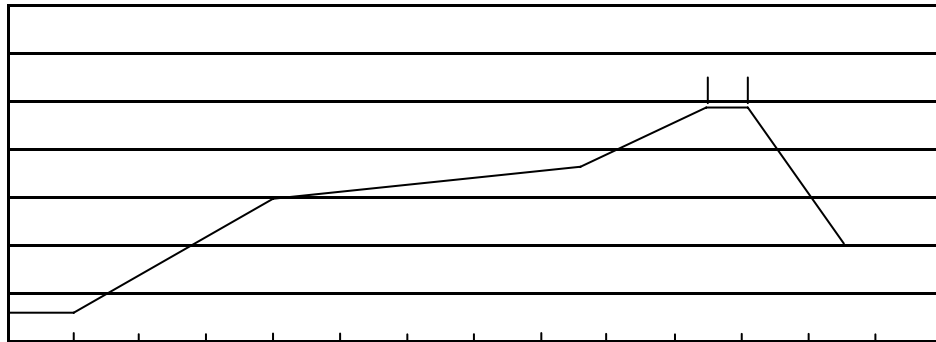


Dc

Note

Dc	Product Type
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Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|-----------|--------|---|
| 1 | 150 | 180 | 60 | 90sec; | 1.Preheating:150~180 , Time:60~90sec. |
| 2 | 245±5 | | 5±0.5sec; | | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

260±5

10±1 sec.

Temp.:260±5

Time:10±1 sec

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
DFN0603	10,000	10	100,000	6	600,000	7 ×8	180×120×180	390×385×205